

DESCRIPTION

The SN75176N used for RS-485/RS-422 communication is a 10Mbps high-speed transceiver for half duplex communication, which includes one driver Device and a receiver.

Equippedwith ± 8kV human mode ESD protection and failure protection circuit,ensuring that when the receiver input is open or short circuited Receiver output logic high level.

If all transmitters attached to the terminal matching bus are disabled (high resistance), the receiver will output logic high Level.

The SN75176N driver does not limit the swing rate and can ensure a communication rate of up to 10Mbps.

SN75176N has a receiver with 1 Unit load input impedance, up to 32 transceivers can be connected to the bus.

In addition, SN75176N also has an built-in overtemperature protection circuit to ensure the chip is not damaged under high temperature conditions.

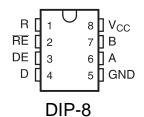
FEATURES

- Provide low current shutdown mode
- Provide industry standard 8-pin SOP packaging
- Up to 32 transceivers are allowed to be mounted on the bus
- · True fail safe receiver compatible with EIA/TIA-485
- Built in over temperature protection circuit ensures that the chip is not damaged due to High temperatures
- Provide enhanced ESD protection for RS-485/ RS-422 A/B pins

APPLICATIONS

- SCSI "Fast 40" Drivers and Receivers
- · Motor Controller/Position Encoder Systems
- Factory Automation

PIN CONFIGURATION

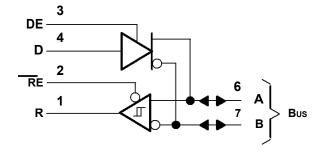


Pin Functions

Р	IN	1/0	DESCRIPTION
NAME	NO.	- I/O	DESCRIPTION
А	6	Bus input/output	Driver output or receiver input (complementary to B)
В	7	Bus input/output	Driver output or receiver input (complementary to A)
D	4	Digital input	Driver data input
DE	3	Digital input	Active-HIGH driver enable
GND	5	Reference potential	Local device ground
R	1	Digital output	Receiver data output
RE	2	Digital input	Active-LOW receiver enable
V _{CC}	8	Supply	4.75-V to 5.25-V supply



LOGIC DIAGRAM



FEATUER DESCRIPTION

DRIVER FUNCTION TABLE

INPUT	ENABLE	OUT	PUTS
D	DE	Α	В
Н	Н	Н	L
L	Н	L	н
Х	L	Z	Z

H = high level,

L = low level,

X = irrelevant, Z = high impedance (off)

RECEIVER FUNCTION TABLE

DIFFERENTIAL INPUTS A–B	EN <u>AB</u> LE RE	OUTPUT R
V _{ID} ≥ 0.2 V	L	н
$-0.2 V < V_{ID} < 0.2 V$	L	?
V _{ID} ≤ –0.2 V	L	L
Х	Н	Z
Open	L	?

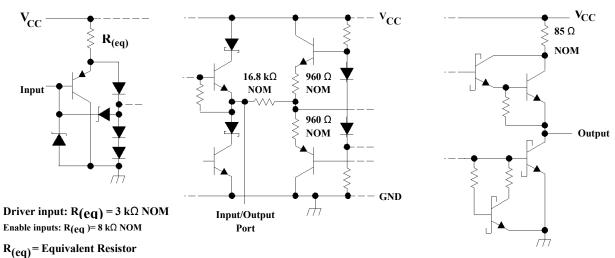
H = high level,

L = low level,

? = indeterminate,

X = irrelevant, Z = high impedance (off)

EQUIVALENT OF EACH INPUT





ABSOLUTE MAXIMUM RATINGS

($V_{CC} = 5V \pm 5\%$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted.)

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

SYMBOL	PARAMETER	MIN	MAX	UNIT
V	Supply voltage ⁽²⁾		7	V
	Voltage range at any bus terminal	-10	15	V
VI	Enable input voltage		5.5	V
$\theta_{_{JA}}$	Package thermal impedance ⁽³⁾⁽⁴⁾		97	°C/W
Тј	Operating virtual junction temperature		150	C
	Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds		260	C
Tstg	Storage temperature range	-65	150	C

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

All voltage values, except differential input/output bus voltage, are with respect to network ground terminal. (2)

(3) Maximum power dissipation is a function of T_{J(max)}, θ_{JA}, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A) / \theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability. The package thermal impedance is calculated in accordance with JESD 51-7.

(4)

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		MIN	TYP	МАХ	UNIT
V _{cc}	Supply voltage	Supply voltage		5	5.25	V
VI or VIC	Voltage at any bus terminal (separately or common mode)				12	V
ALOLAIC	voltage at any bus terminal (separat			-7	V	
VIH	High-level input voltage	D, DE, and RE	2			V
V⊫	Low-level input voltage	D, DE, and RE			0.8	V
V	Differential input voltage	Differential input voltage ⁽¹⁾			±12	V
		Driver			-60	mA
I _{OH}	High-level output current	Receiver			-400	μA
		Driver			60	
IOL	Low-level output current	Receiver			8	mA
T _A	Operating free-air temperature		0		70	C

(1) Differential input/output bus voltage is measured at the noninverting terminal A, with respect to the inverting terminal B.



DRVER SECTION Electrical Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

SYMBOL	PARAMETER	TEST CON	DITIONS ⁽¹⁾	MIN	TYP ⁽²⁾	МАХ	UNIT
V _{IK}	Input clamp voltage	lj = –18 mA				-1.5	V
VO	Output voltage	I _O = 0		0		6	V
Vod1	Differential output voltage	IO = 0		1.5	3.6	6	V
		R_ = 100 Ω		$1/2 V_{\text{OD1}} \text{ or } 2^{(3)}$			
VOD2	Differential output voltage	RL = 54 Ω		1.5	2.5	5	V
Vod3	Differential output voltage	See (4)		1.5		5	V
	Change in magnitude of differential output voltage ⁽⁵⁾	RL = 54 Ω or 100 Ω				±0.2	V
Voc	Common-mode output voltage	RL = 54 Ω or 100 Ω				+3 _1	V
∆ VOC	Change in magnitude of common-mode output voltage ^(マ)	RL = 54 Ω or 100 Ω				±0.2	V
	Output current	Output disabled ⁽⁶⁾	V _O = 12 V			1	mA
о	ouput ouriont		V _O = -7 V			-0.8	
Ін	High-level input current	VI = 2.4 V				20	μA
IL	Low-level input current	VI = 0.4 V				-400	μA
		V _O = -7 V				-250	
		$V_{\Omega} = 0$				-150	
los	Short-circuit output current	v – v o cc				250	mA
		V _O = 12 V				250	
			Outputs enabled		42	70	
lcc	Supply current (total package)	No load	Outputs disabled		26	35	mA

(1) The power-off measurement in ANSI Standard TIA/EIA-422-B applies to disabled outputs only and is not applied to combined inputs and outputs.

All typical values are at V_{CC} = 5 V and T_A = 25°C. (2)

(4) The minimum V_{OD2} with a 100-Ω load is either 1/2 V_{OD1} or 2 V, whichever is greater.
 (4) See ANSI Standard TIA/EIA-485-A, Figure 3.5, Test Termination Measurement 2.

[VOD] and [VOC] are the changes in magnitude of VOD and VOC, respectively, that occur when the input is changed from a high level (5) to a low level.

This applies for both power on and off; refer to ANSI Standard TIA/EIA-485-A for exact conditions. The TIA/EIA-422-B limit does not (6) apply for a combined driver and receiver terminal.

Switching Characteristics

 $V_{CC} = 5 V, R_I = 110 \Omega, T_A = 25^{\circ}C$ (unless otherwise noted)

SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP	МАХ	UNIT
$t_{d(\text{OD})}$	Differential-output delay time	RL = 54 Ω		15	22	ns
t _{t(OD)}	Differential-output transition time	RL = 54 Ω		20	30	ns
t _{PZH}	Output enable time to high level			85	120	ns
t _{PZL}	Output enable time to low level			40	60	ns
t _{PHZ}	Output disable time from high level			150	250	ns
t _{PLZ}	Output disable time from low level			20	30	ns



Symbol Equivalents

DATA SHEET PARAMETER	TIA/EIA-422-B	TIA/EIA-485-A
Vo	Voa, Vob	Voa, Vob
VOD1	Vo	Vo
V _{OD2}	V _t (R _L = 100 Ω)	V _t (R _L = 54 Ω)
V _{OD3}		V _t (test termination measurement 2)
	$ V_t - \overline{V_t} $	$ V_{t} - V_{t} $
Voc	V _{os}	V _{os}
	$ V_{OS} - \overline{V}_{OS} $	$ V_{OS} - \overline{V}_{OS} $
l _{os}	I _{sa} , I _{sb}	
l0	I _{xa} , I _{xb}	lia, lib

RECEIVER SECTION Electrical Characteristics

over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature (unless otherwise noted)

SYMBOL	PARAMETER	TEST CONDITIONS		MIN	TYP ⁽¹⁾	MAX	UNIT
V _{IT+}	Positive-going input threshold voltage	Vo = 2.7 V, Io = -0.4	1 mA			0.2	V
V _{IT-}	Negative-going input threshold voltage	VO= 0.5 V, IO = 8 m/	ł	-0.2 ⁽²⁾			V
V _{hys}	Input hysteresis voltage (VIT+ – VIT–)				50		mV
VIK	Enable Input clamp voltage	lj = –18 mA				-1.5	V
V _{OH}	High-level output voltage	VID = 200 mV, IOH =	–400 uA	2.7			V
Vol	Low-level output voltage	VID = -200 mV, IOL	= 8 mA			0.45	V
loz	High-impedance-state output current	VO = 0.4 V to 2.4 V				±20	μA
	Line input current	Other input = $0 V^{(3)}$	VJ = 12 V			1	mA
h			V _I = -7 V			-0.8	iii/ (
IIH	High-level enable input current	VIH = 2.7 V				20	μA
lı.	Low-level enable input current	VIL = 0.4 V				-100	μA
rj	Input resistance	VI = 12 V		12			kΩ
los	Short-circuit output current			-15		-85	mA
			Outputs enabled		42	55	
cc	Supply current (total package)	No load	Outputs disabled		26	35	mA

 All typical values are at V_{CC} = 5 V, T_A = 25°C.
 The algebraic convention, in which the less positive (more negative) limit is designated minimum, is used in this data sheet for commonmode input voltage and threshold voltage levels only.

(3) This applies for both power on and power off. Refer to EIA Standard TIA/EIA-485-A for exact conditions.

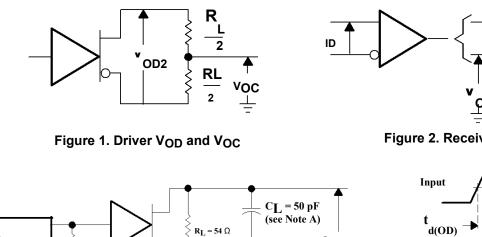
Switching Characteristics

 $V_{CC} = 5 V, C_{L} = 15 pF, T_{A} = 25^{\circ}C$

SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t PLH	Propagation delay time, low- to high-level output	$\lambda = -0.45$		21	35	nc
t PHL	Propagation delay time, high- to low-level output	V _{ID} = 0 to 3 V		23	35	ns
tрzн	Output enable time to high level			10	20	nc
t PZL	Output enable time to low level			12	20	ns
tрнz	Output disable time from high level			20	35	20
t PLZ	Output disable time from low level	1		17	25	ns



Parameter Measurement Information



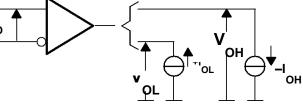
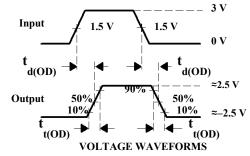


Figure 2. Receiver VOH and VOL



TEST CIRCUIT C_{L} includes probe and jig capacitance.

3 V

50Ω

Generator

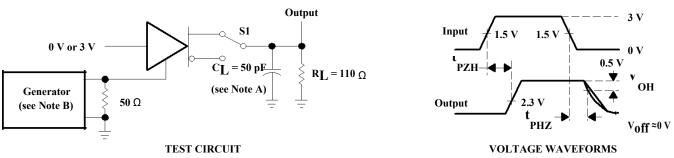
(see Note B)

Α.

B. The input pulse is supplied by a generator having the following characteristics: PRR ≤1 MHz, 50% duty cycle, $t_{f} \le 6$ ns, $t_{f} \le 6$ ns, $Z_{O} = 50 \Omega$.

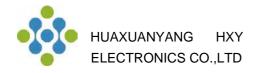
Figure 3. Driver Test Circuit and Voltage Waveforms

Output

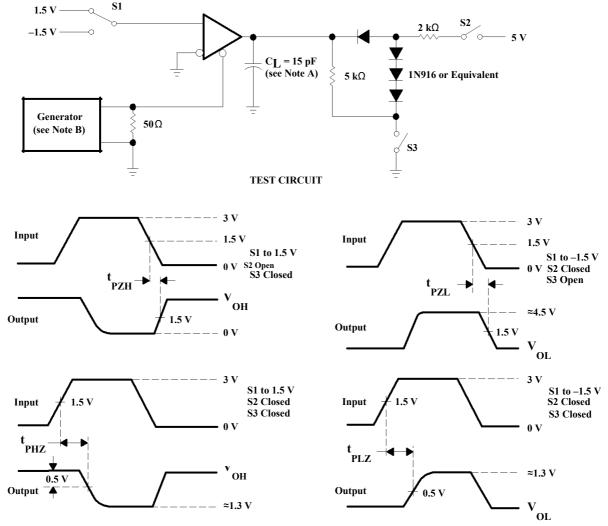


- A. CL includes probe and jig capacitance.
- B. The input pulse is supplied by a generator having the following characteristics: PRR ≤1 MHz, 50% duty cycle, $t_{f} \le 6$ ns, $t_{f} \le 6$ ns, $Z_{O} = 50 \Omega$.

Figure 4. Driver Test Circuit and Voltage Waveforms



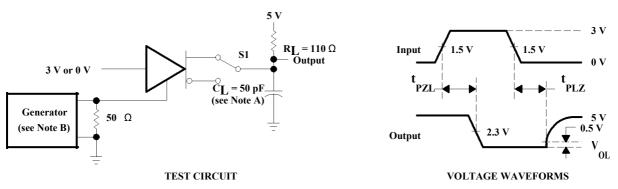




VOLTAGE WAVEFORMS

- A. CL includes probe and jig capacitance.
- B. The input pulse is supplied by a generator having the following characteristics: PRR ≤1 MHz, 50% duty cycle, $t_r \le 6$ ns, $t_f \le 6$ ns, $Z_O = 50 \Omega$.

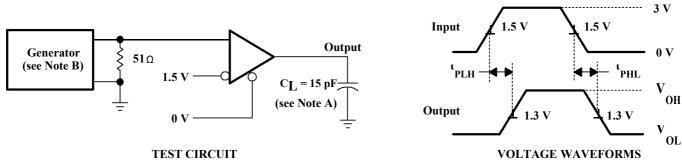
Figure 5. Receiver Test Circuit and Voltage Waveforms



- A. CL includes probe and jig capacitance.
- B. The input pulse is supplied by a generator having the following characteristics: PRR ≤1 MHz, 50% duty cycle, $t_r \le 6$ ns, $t_f \le 6$ ns, $Z_O = 50 \Omega$.

Figure 6. Driver Test Circuit and Voltage Waveforms

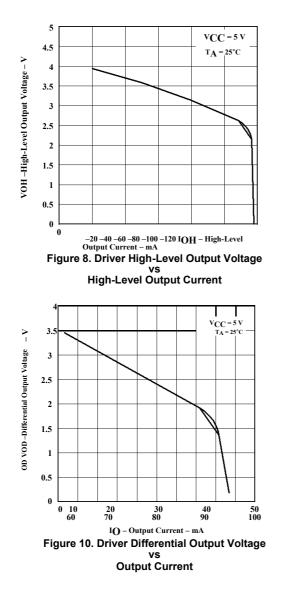




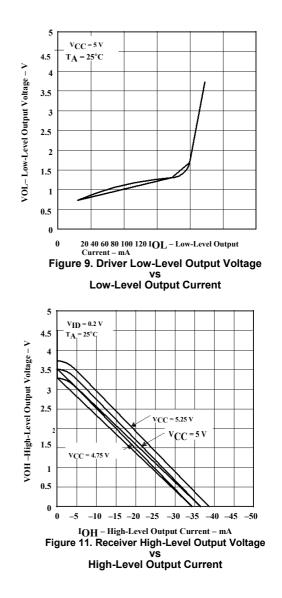
TEST CIRCUIT

- CL includes probe and jig capacitance. Α.
- The input pulse is supplied by a generator having the following characteristics: PRR ≤ 1 MHz, 50% duty cycle, t_r ≤ 6 ns, Β. $t_f \le 6 \text{ ns}, Z_O = 50 \Omega.$

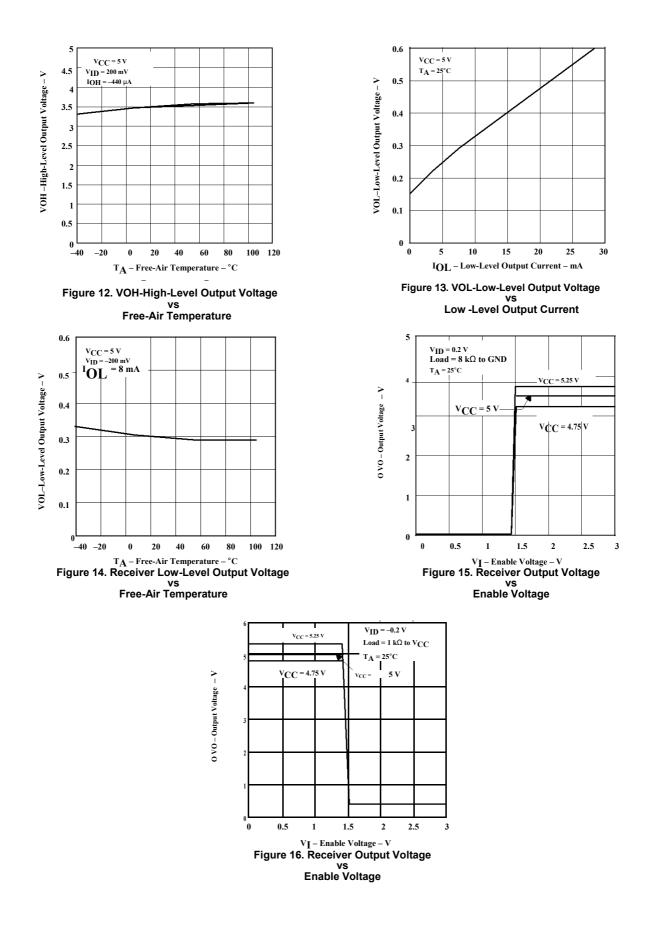
Figure 7. Receiver Test Circuit and Voltage Waveforms



TYPOCAL CHARACTERISTICS

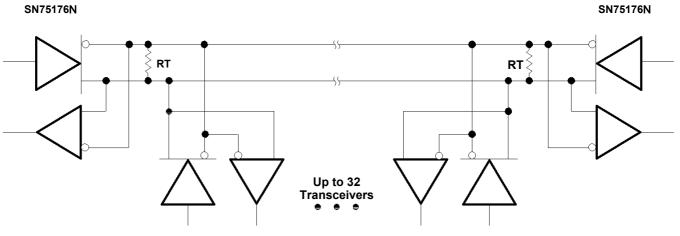








APPLICATION INFORMATION



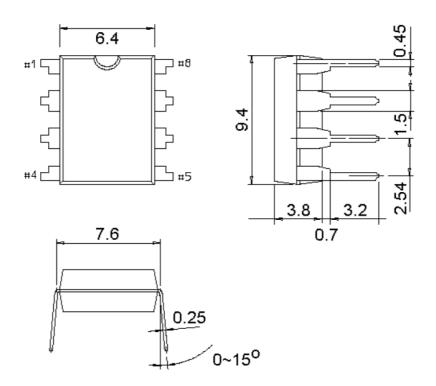
The line should be terminated at both ends in its characteristic impedance ($R_T = Z_O$). Stub lengths off the main line should be kept as short as possible.

Figure 17. Typical Application Circuit



PACKAGE OUTLINE DIMENSIONS

DIP-8





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